

MOS FIELD EFFECT TRANSISTOR 2SK3755

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3755 is N-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3755	Isolated TO-220

FEATURES

• Super low on-state resistance

 $R_{DS(on)1} = 12 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 23 \text{ A})$

 $R_{DS(on)2}$ = 18 m Ω MAX. (VGS = 4.5 V, ID = 23 A)

- Low Ciss: Ciss = 1200 pF TYP.
- Built-in gate protection diode

(Isolated TO-220)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V _{GS} = 0 V)	VDSS	40	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±45	Α
Drain Current (pulse) Note1	I _{D(pulse)}	±140	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	24	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	23	Α
Single Avalanche Energy Note2	Eas	53	mJ
Repetitive Avalanche Energy Note3	Ear	53	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- 2. Starting T_{ch} = 25°C, V_{DD} = 20 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V
- **3.** IAR ≤ 23 A, Tch $\leq 150^{\circ}$ C

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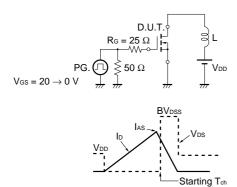


ELECTRICAL CHARACTERISTICS (TA = 25°C)

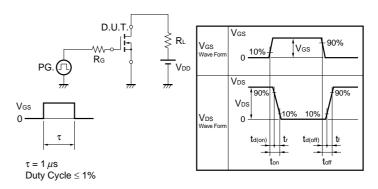
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 40 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance Note	y fs	V _{DS} = 10 V, I _D = 23 A	12	25		S
Drain to Source On-state Resistance Note	R _{DS(on)1}	V _{GS} = 10 V, I _D = 23 A		9.7	12	mΩ
	R _{DS(on)2}	V _{GS} = 4.5 V, I _D = 23 A		12.9	18	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1200		pF
Output Capacitance	Coss	V _{GS} = 0 V		330		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		120		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 20 V, I _D = 23 A		10		ns
Rise Time	tr	V _{GS} = 10 V		4		ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		35		ns
Fall Time	tf			5		ns
Total Gate Charge	Q _G	V _{DD} = 32 V		25.5		nC
Gate to Source Charge	Qgs	V _{GS} = 10 V		4.2		nC
Gate to Drain Charge	Q _{GD}	I _D = 45 A		7.1		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 45 A, V _{GS} = 0 V		0.98	1.5	V
Reverse Recovery Time	trr	I _F = 45 A, V _{GS} = 0 V		29		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		30		nC

Note Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY



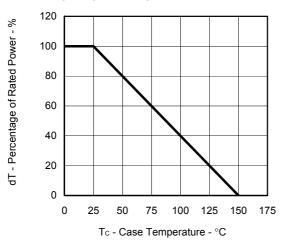
TEST CIRCUIT 2 SWITCHING TIME



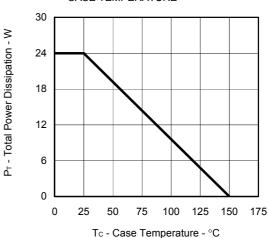
TEST CIRCUIT 3 GATE CHARGE

TYPICAL CHARACTERISTICS (TA = 25°C)

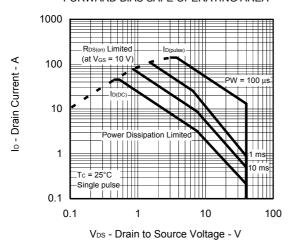
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



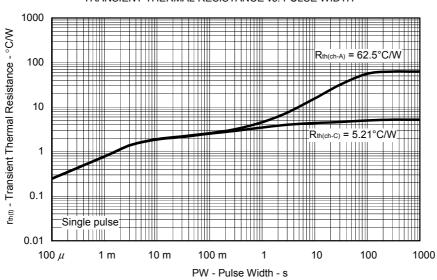
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



FORWARD BIAS SAFE OPERATING AREA



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



lo - Drain Current - A

80

60

40

20

0

0

DRAIN TO SOURCE VOLTAGE 160 140 120 100

1

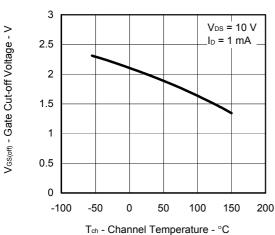
DRAIN CURRENT vs.

V_{DS} - Drain to Source Voltage - V

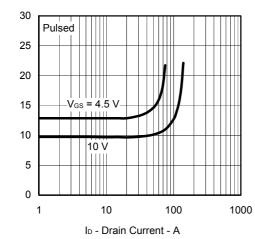
2

3

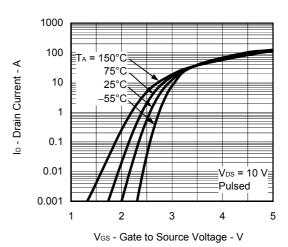




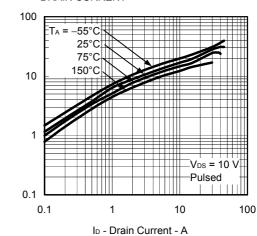
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



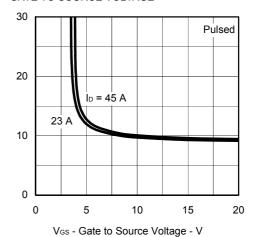
FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



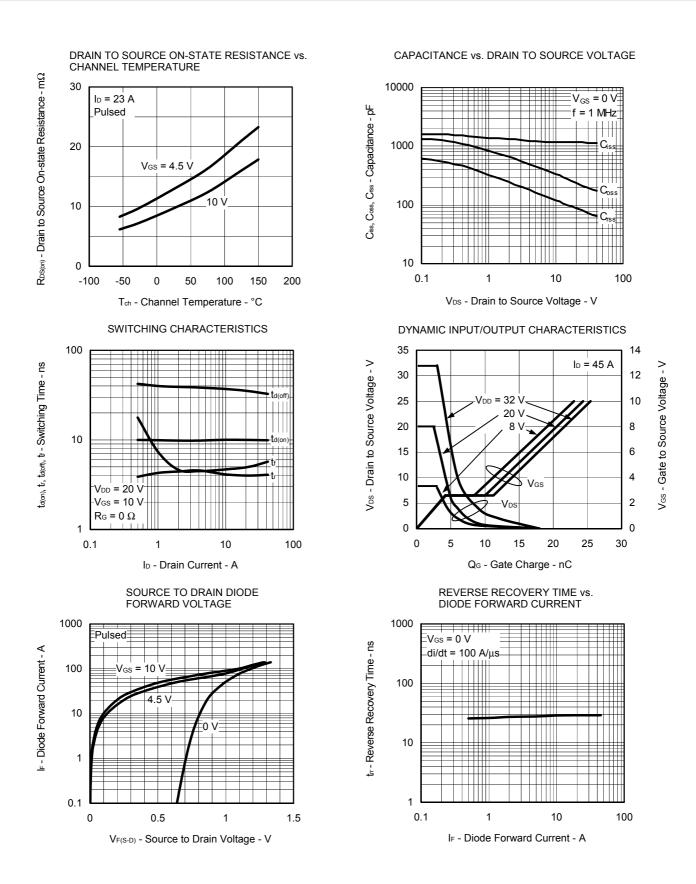
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



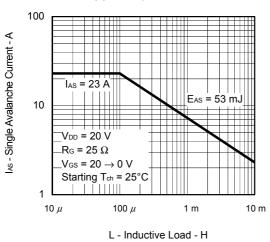
R_{DS(m)} - Drain to Source On-state Resistance - mΩ

l y_s | - Forward Transfer Admittance

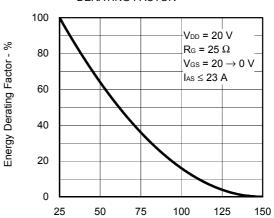
R_{DS(ση)} - Drain to Source On-state Resistance - mΩ



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD

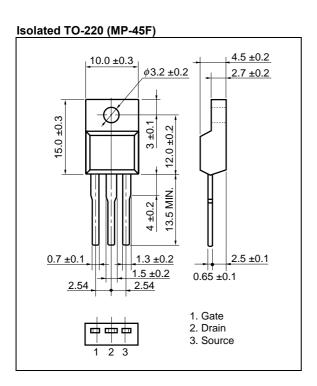


SINGLE AVALANCHE ENERGY DERATING FACTOR

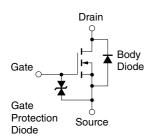


Starting T_{ch} - Starting Channel Temperature - $^{\circ}\text{C}$

PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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